

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## **Dual Power HiPerFET™ Module**

## VMM 45-02F

 $V_{DSS} = 200 V$ =45A $R_{DS(on)} = 45 \text{ m}\Omega$ 

Phaseleg Configuration High dv/dt, Low  $t_{rr}$ , HDMOS<sup>TM</sup> Family

5 o 4 o 60

### Preliminary Data

3 =	Source 2 4 =	= Source 1, Drain 2 = Kelvin Source 1 = Gate 2
	1 1	2 4
· · · · 1 IU-	'44U AA	3 0

TO-240 AA

Symbol	Conditions	Maximum	Maximum Ratings		
V <sub>DSS</sub> V <sub>DGR</sub>	$T_J = 25$ °C to 150°C $T_J = 25$ °C to 150°C; $R_{GS} = 10 \text{ k}\Omega$	200 200			
V <sub>GS</sub>	Continuous Transient	±20 ±30	-		
I <sub>D25</sub> I <sub>D80</sub> I <sub>DM</sub>	$T_{C} = 25^{\circ}C$ $T_{C} = 80^{\circ}C$ $T_{C} = 25^{\circ}C$ , $t_{p} = 10 \mu s$ , pulse width limited by	45 34 / T <sub>JM</sub> 180	Α		
P <sub>tot</sub>	T <sub>C</sub> = 25°C	190	W		
T <sub>J</sub> T <sub>JM</sub> T <sub>stg</sub>		-40 +150 150 -40 +125	°C		
V <sub>ISOL</sub>	50/60 Hz $t = 1 \text{ min}$ $I_{ISOL} \le 1 \text{ mA}$ $t = 1 \text{ s}$	3000 3600			
M <sub>d</sub>	Mounting torque(M5 or 10-32 UNF) Terminal connection torque (M5)	2.5-4.0/22-35 2.5-4.0/22-35			
Weight	Typical including screws	90	g		

- Two MOSFET's in phaseleg config.
- · International standard package
- Direct copper bonded Al<sub>2</sub>O<sub>3</sub> ceramic base plate
- Isolation voltage 3600 V~
- Low  $R_{DS(on)}$  HDMOS<sup>TM</sup> process

#### **Applications**

- · Switched-mode and resonant-mode power supplies
- Uninterruptible power supplies (UPS)

#### **Advantages**

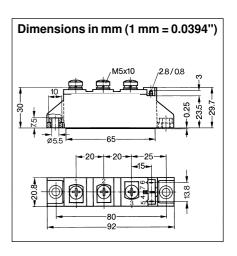
- · Easy to mount with two screws
- · Space and weight savings
- · High power density
- Low losses

Symbol	Conditions $(T_J = 2)$	Characteristic Values (T <sub>J</sub> = 25°C, unless otherwise specified)			
		min.	typ.	max.	
V <sub>DSS</sub>	$V_{GS} = 0 V$ , $I_D = 1 mA$ $V_{DS} = V_{GS}$ , $I_D = 4 mA$	200			٧
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$	2		4	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V DC}, V_{DS} = 0$			500	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0 V, T_{J} = V_{DS} = 0.8 \cdot V_{DSS}, V_{GS} = 0 V, T_{J} = 0.8 \cdot V_{DSS}$	25°C 125°C		15 1	μA mA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 0.5 \cdot I_{D25}$ Pulse test, $t \le 300 \mu\text{s}, \text{ duty cycle d}$	≤ 2%	39	45	mΩ

Data per MOSFET unless otherwise stated.



Symbol	Conditions Characteristic Values (T <sub>J</sub> = 25°C, unless otherwise specified)				
		min.	typ.	max.	
g <sub>fs</sub>	$V_{DS} = 10 \text{ V}; I_D = 0.5 \cdot I_{D25} \text{ pulsed}$	20	30		S
C <sub>iss</sub>	)		4800	7500	рF
$C_{oss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ M}$	Hz	900	2250	рF
$C_{rss}$	J		310	750	рF
t <sub>d(on)</sub>	)		40		ns
t <sub>r</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{SS}$	$I_{D} = 0.5 \cdot I_{D25}$	45		ns
$\mathbf{t}_{d(off)}$	$R_G = 1 \Omega$ (External), resistive	load	300		ns
$\mathbf{t}_{f}$	J		45		ns
$\mathbf{Q}_{g}$	)		190	225	nC
$\mathbf{Q}_{gs}$	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_{SS}$	$_{D} = 0.5 \cdot I_{D25}$	35	55	пC
$\mathbf{Q}_{gd}$	J		95	115	nC
R <sub>thJC</sub>				0.63	K/W
$\mathbf{R}_{thCH}$	heatsink compound applied		0.3		K/W
ds	Creepage distance on surface	12.7			mm
$d_{A}$	Strike distance through air	9.6			mm
а	Allowable acceleration			501	m/s²



#### Source-Drain Diode

#### **Characteristic Values**

 $(T_J = 25$ °C, unless otherwise specified)

Symbol	Conditions	min.	typ.	max.	
Is	$V_{GS} = 0 V$			45	Α
I <sub>SM</sub>	Repetitive; pulse width limited by $T_{\mbox{\tiny JM}}$			180	Α
V <sub>SD</sub>	$\begin{split} I_F &= I_S; \ V_{GS} = 0 \ V, \\ \text{Pulse test, } t \leq 300 \ \mu\text{s, duty cycle d} \leq 2\% \end{split}$		0.9	1.2	٧
t <sub>rr</sub>	$I_F = I_S$ , $-di/dt = 100 \text{ A/}\mu\text{s}$ , $V_{DS} = 100 \text{ V}$ , $V_{GS} = 0 \text{ V}$		200	400	ns